CLAIM AMENDMENTS

Please muend the claims as follows:

- 1-4. (Cancelled)
- 5. (Currently Amended) A substrate for growth of a nitride semiconductor layer on a sapphire substrate comprising:

an AbO, layer provided on the sapphire substrate; and

a <u>second</u> layer including N, O and Al as-separately provided on the <u>Al₂O₃ layer</u>, supplies substrate, and

wherein the second layer contacts with the sapphire substrate Al₂O₁ layer at a first surface thereof of the second layer and is formed such that a proportion of N to a composition ratio of N, O and Al in the first surface is smaller than that of N to the composition ratio of N, O and Al in a second surface of the second layer contacting with a nitride semiconductor layer and that a proportion of O to the composition ratio in the first surface is larger than that of O to the composition ratio in the second surface.

- 6. (Currently Amended) The substrate for growth of nitride semiconductor according to claim 5, wherein a cap layer made of Al₂O₃ is provided as the uppermost layer of the substrate for growth of nitride semiconductor.
- 7. (Currently Amended) A substrate for growth-of-nitride-semiconductor for growth of a nitride semiconductor layer on a sapplier substrate comprising:

an Al₂O₃ layer as separately provided on the sapphire substrate; and either one layer of an AlON layer or an AlN layer provided on said Al₂O₃ layer.

- 8. (Currently Amended) The substrate for growth of nitride-semiconductor according to claim 7, wherein a cap layer made of Al₂O₃ is provided as the uppermost layer of the substrate for growth of nitride semiconductor.
- 9. (Currently Amended) A substrate for growth of nitride-semiconductor for growth of a nitride semiconductor layer on a sapphire substrate comprising:

an Al₂Q₃ layer as separately provided on the sapphire substrate;

an AION layer which is a first layer;

an AlN layer which is a second layer; and

- a structure in which the first layer and the second layer are deposited on the Al_2O_3 layer in this order.
- 10. (Currently Amended) The substrate for growth of nitride semiconductor according to claim 9, wherein a cap layer made of ΛI_2O_3 is provided as the uppermost layer of the substrate for growth of nitride semiconductor.

11. (New) A substrate for growth of a nitride semiconductor layer on a sapphire substrate comprising:

a first layer comprised of Al₂O₃, the first layer being disposed against the sapphire substrate at a first surface; and

a second layer including N, O and Al, the second layer being disposed on the first layer, the second layer being configured to be disposed against a nitride semiconductor layer at a second surface,

wherein a proportion of N to a composition ratio of N, O and Al in the first surface is smaller than a proportion of N to the composition ratio of N, O and Al in the second surface and a proportion of O to the composition ratio of N, O and Al in the first surface is larger than a proportion of O to the composition ratio of N, O and Al in the second surface.

12. (New) The substrate according to claim 11, wherein a cap layer made of Al₂O₃ is provided as the appearment layer of the substrate for growth of nitride semiconductor.